

## **TECHNICAL SPEC FOR Track system**

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**System Model:**

**TEL Clean Track MK8Z, build over SMIF**

**Tool status :**

The tool, inclusive photoresist pumps, and the bypack units have been flushed and cleaned with solvent/DI water, and dry cleaned with CCA. The solvent lines (HMDS, Resist, thinner, developer have been disconnected from the tool), as well as the electric power supply lines. The bypacks of the tool are situated in the basement under the fab. The water cooling line and signal cables are still connected between process unit and bypack. Decommissioning was done by trained Litho technicians.

**Specific Model: MD8271055**

**Wafer size: 6 inch**

**Wafer type: Jeida flat**

**Wafer flow:**

**Number coater/developer modules: 2C/2D**

**Inline system: yes**

**Resists / Coaters: 3 (mini)**

**E2 Develop nozzle kits: 2**

**RRC Pumps & kits: 2**

**Dual-stream nozzles / Developer: none**

**Solvent & developer auto supply systems: Yes**

**Temperature / Humidity controller: Yes**

**Configuration/layout of each block:**

GEM:yes

AVG:

HMDS Bubblers: Venturi

Power supply: 208 V, 3 Phase, AC Transformer:

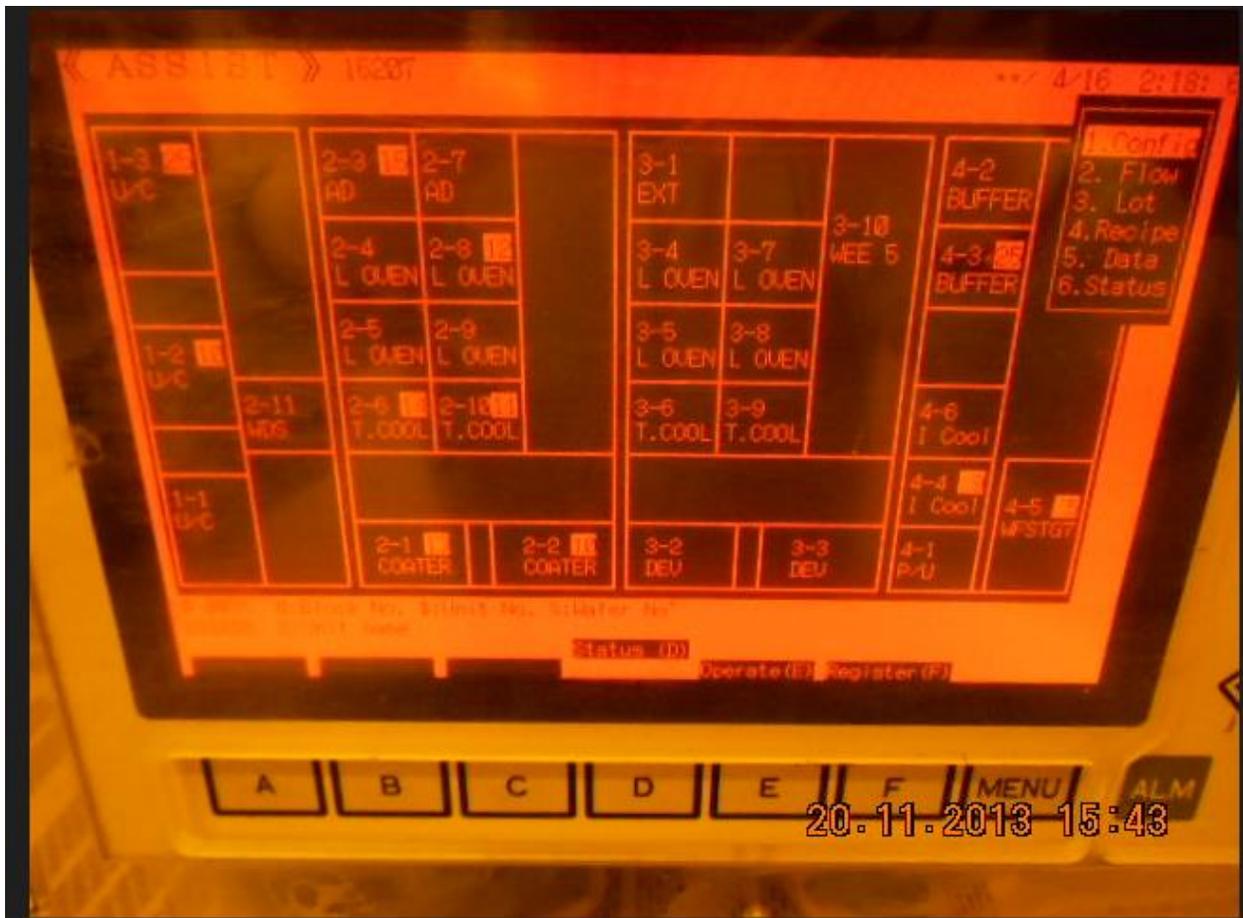
Vintage:

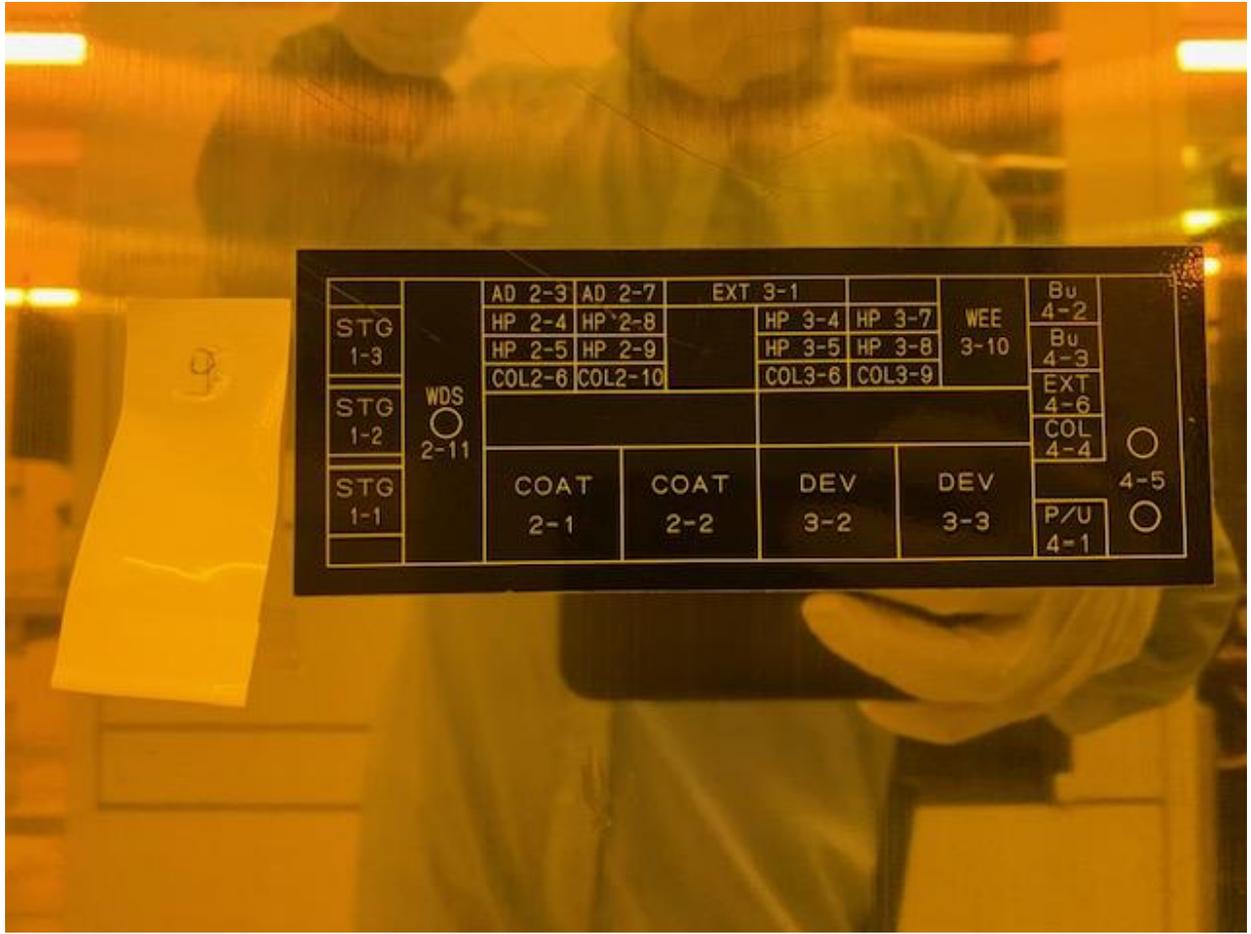
Missing parts: none

Defected parts: none

Operating system:

<u>Machine</u>	COATER 9
<u>S.N. :</u>	MD8271055
<u>Manufacturing date</u>	Jan-97
<u>Machine soft type</u>	Mk 8Z
<u>ARDiMuS</u>	OK
<u>Main Controller</u>	MK8Z2.81
<u>Process Block1</u>	M8B6083D.00
<u>Process Block2</u>	M8B6083D.00
<u>Process Block3</u>	M8B6083D.00
<u>Process Block 4</u>	M8B6083D.00
<u>Controller type/model</u>	FC-9801F model 2
<u>Disk</u>	Command Post
<u>Floppy drive</u>	Built-in





		AD 2-3	AD 2-7	EXT 3-1				Bu 4-2	
STG 1-3	WDS ○ 2-11	HP 2-4	HP 2-8		HP 3-4	HP 3-7	WEE 3-10	Bu 4-3	
		HP 2-5	HP 2-9		HP 3-5	HP 3-8		EXT 4-6	
		COL2-6	COL2-10		COL3-6	COL3-9		COL 4-4	○ 4-5
STG 1-2									
STG 1-1		COAT 2-1	COAT 2-2		DEV 3-2	DEV 3-3		P/U 4-1	○